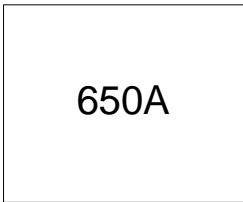


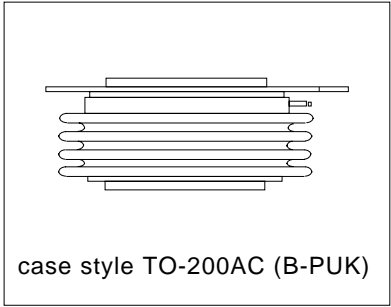
Features

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AC (B-PUK)
- High profile hockey-puk



Typical Applications

- DC motor controls
- Controlled DC power supplies
- AC controllers



Major Ratings and Characteristics

Parameters	ST330C..L	Units
$I_{T(AV)}$	650	A
@ T_{hs}	55	°C
$I_{T(RMS)}$	1230	A
@ T_{hs}	25	°C
I_{TSM}	@ 50Hz 9000	A
	@ 60Hz 9420	A
I^2t	@ 50Hz 405	KA ² s
	@ 60Hz 370	KA ² s
V_{DRM}/V_{RRM}	400 to 2000	V
t_q typical	100	μs
T_J	- 40 to 125	°C

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ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , max. repetitive peak and off-state voltage V	V_{RSM} , maximum non-repetitive peak voltage V	I_{DRM}/I_{RRM} max. @ $T_J = T_J$ max mA
ST2330C..L	04	400	500	50
	08	800	900	
	12	1200	1300	
	14	1400	1500	
	16	1600	1700	
	18	1800	1900	
	20	2000	2100	

On-state Conduction

Parameter	ST330C..L	Units	Conditions	
$I_{T(AV)}$ Max. average on-state current @ Heatsink temperature	650 (314)	A	180° conduction, half sine wave double side (single side) cooled	
	55 (75)	°C		
$I_{T(RMS)}$ Max. RMS on-state current	1230	A	DC @ 25°C heatsink temperature double side cooled	
I_{TSM} Max. peak, one-cycle non-repetitive surge current	9000		t = 10ms	No voltage reappplied
	9420		t = 8.3ms	100% V_{RRM} reappplied
	7570		t = 10ms	Sinusoidal half wave, Initial $T_J = T_J$ max.
	7920	t = 8.3ms		
I^2t Maximum I^2t for fusing	405	KA ² s	t = 10ms	No voltage reappplied
	370		t = 8.3ms	100% V_{RRM} reappplied
	287		t = 10ms	Sinusoidal half wave, Initial $T_J = T_J$ max.
	262		t = 8.3ms	
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	4050	KA ² /s	t = 0.1 to 10ms, no voltage reappplied	
$V_{T(TO)1}$ Low level value of threshold voltage	0.91	V	(16.7% $\times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$), $T_J = T_J$ max.	
$V_{T(TO)2}$ High level value of threshold voltage	0.93		($I > \pi \times I_{T(AV)}$), $T_J = T_J$ max.	
r_{t1} Low level value of on-state slope resistance	0.57	mΩ	(16.7% $\times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}$), $T_J = T_J$ max.	
r_{t2} High level value of on-state slope resistance	0.57		($I > \pi \times I_{T(AV)}$), $T_J = T_J$ max.	
V_{TM} Max. on-state voltage	1.90	V	$I_{pk} = 1730A$, $T_J = T_J$ max, $t_p = 10ms$ sine pulse	
I_H Maximum holding current	600	mA	$T_J = 25^\circ C$, anode supply 12V resistive load	
I_L Typical latching current	1000			

Switching

Parameter	ST330C..L	Units	Conditions
di/dt Max. non-repetitive rate of rise of turned-on current	1000	A/ μs	Gate drive 20V, 20Ω, $t_r \leq 1\mu s$ $T_J = T_J$ max, anode voltage $\leq 80\% V_{DRM}$
t_d Typical delay time	1.0	μs	Gate current 1A, $di_g/dt = 1A/\mu s$ $V_d = 0.67\% V_{DRM}$, $T_J = 25^\circ C$
t_q Typical turn-off time	100		$I_{TM} = 550A$, $T_J = T_J$ max, $di/dt = 40A/\mu s$, $V_R = 50V$ $dv/dt = 20V/\mu s$, Gate 0V 100Ω, $t_p = 500\mu s$

Blocking

Parameter	ST330C..L	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	500	V/ μ s	$T_J = T_J$ max. linear to 80% rated V_{DRM}
I_{RRM} I_{DRM} Max. peak reverse and off-state leakage current	50	mA	$T_J = T_J$ max, rated V_{DRM}/V_{RRM} applied

Triggering

Parameter	ST330C..L		Units	Conditions
P_{GM} Maximum peak gate power	10.0		W	$T_J = T_J$ max, $t_p \leq 5$ ms
$P_{G(AV)}$ Maximum average gate power	2.0			
I_{GM} Max. peak positive gate current	3.0		A	$T_J = T_J$ max, $t_p \leq 5$ ms
$+V_{GM}$ Maximum peak positive gate voltage	20		V	$T_J = T_J$ max, $t_p \leq 5$ ms
$-V_{GM}$ Maximum peak negative gate voltage	5.0			
I_{GT} DC gate current required to trigger	TYP.	MAX.	mA	$T_J = -40^\circ\text{C}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ Max. required gate trigger/ current/ voltage are the lowest value which will trigger all units 12V anode-to-cathode applied
	200	-		
	100	200		
V_{GT} DC gate voltage required to trigger	2.5	-	V	$T_J = -40^\circ\text{C}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$
	1.8	3.0		
	1.1	-		
I_{GD} DC gate current not to trigger	10		mA	$T_J = T_J$ max Max. gate current/voltage not to trigger is the max. value which will not trigger any unit with rated V_{DRM} anode-to-cathode applied
V_{GD} DC gate voltage not to trigger	0.25			

Thermal and Mechanical Specification

Parameter	ST330C..L	Units	Conditions
T_J Max. operating temperature range	-40 to 125	$^\circ\text{C}$	
T_{stg} Max. storage temperature range	-40 to 150		
R_{thJ-hs} Max. thermal resistance, junction to heatsink	0.11	K/W	DC operation single side cooled
	0.06		DC operation double side cooled
R_{thC-hs} Max. thermal resistance, case to heatsink	0.011	K/W	DC operation single side cooled
	0.005		DC operation double side cooled
F Mounting force, $\pm 10\%$	9800	N	
	(1000)	(Kg)	
wt Approximate weight	250	g	
Case style	TO-200AC (B-PUK)		See Outline Table

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ΔR_{thJ-hs} Conduction

(The following table shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction		Rectangular conduction		Units	Conditions
	Single Side	Double Side	Single Side	Double Side		
180°	0.012	0.010	0.008	0.008	K/W	$T_J = T_{J \text{ max.}}$
120°	0.014	0.015	0.014	0.014		
90°	0.018	0.018	0.019	0.019		
60°	0.026	0.027	0.027	0.028		
30°	0.045	0.046	0.046	0.046		

Ordering Information Table

Device Code							
ST	33	0	C	16	L	1	
①	②	③	④	⑤	⑥	⑦	⑧
1	-	Thyristor	2	-	Essential part number	3	-
3	-	0 = Converter grade	4	-	C = Ceramic Puk	5	-
5	-	Voltage code: Code x 100 = V_{RRM} (See Voltage Rating Table)	6	-	L = Puk Case TO-200AC (B-PUK)	7	-
7	-	0 = Eyelet terminals (Gate and Auxiliary Cathode Unsoldered Leads)		-	1 = Fast-on terminals (Gate and Auxiliary Cathode Unsoldered Leads)		-
	-	2 = Eyelet terminals (Gate and Auxiliary Cathode Soldered Leads)		-	3 = Fast-on terminals (Gate and Auxiliary Cathode Soldered Leads)		-
8	-	Critical dv/dt: None = 500V/ μ sec (Standard selection)		-	L = 1000V/ μ sec (Special selection)		-

Outline Table

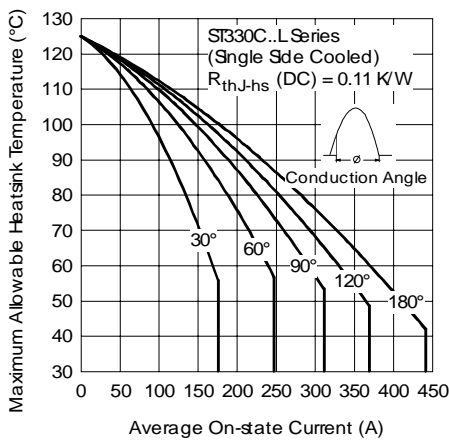
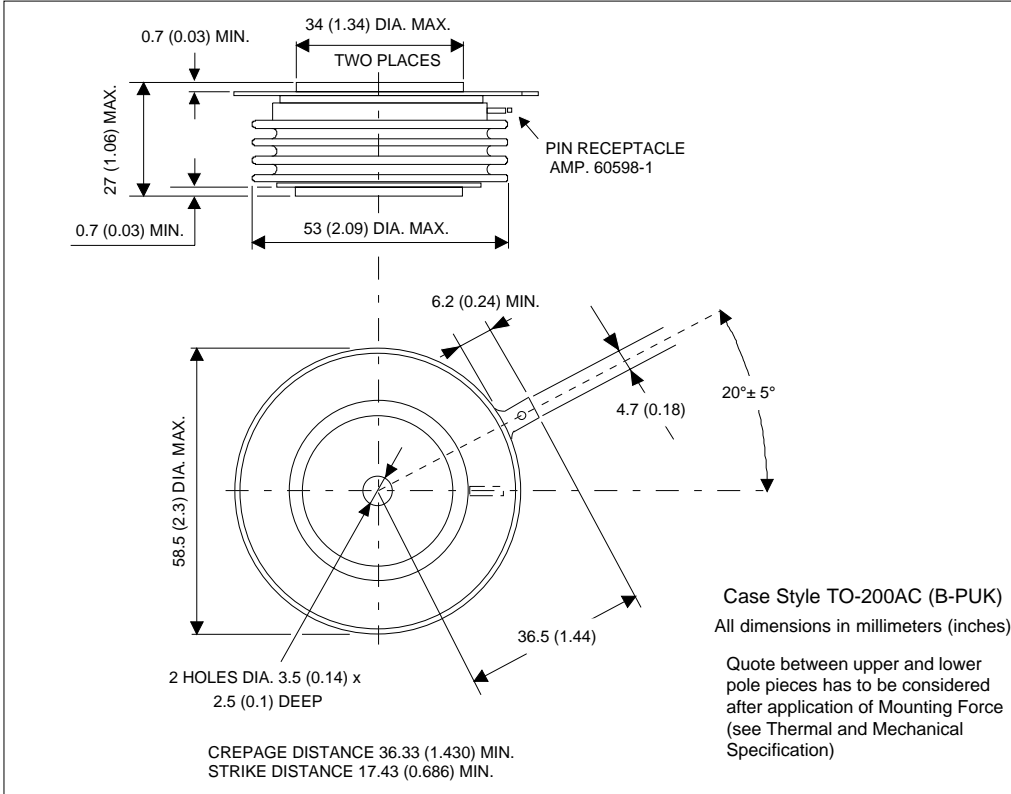


Fig. 1 - Current Ratings Characteristics

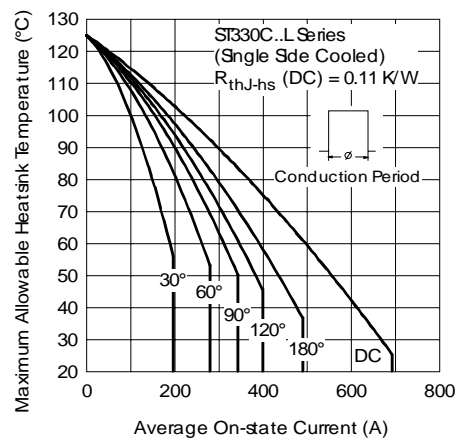


Fig. 2 - Current Ratings Characteristics

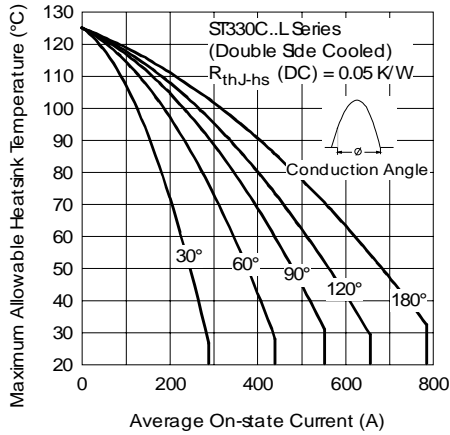


Fig. 3 - Current Ratings Characteristics

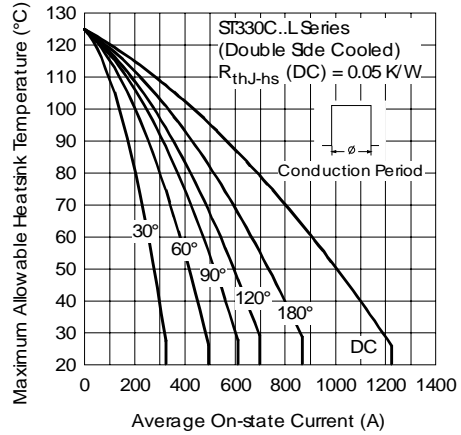


Fig. 4 - Current Ratings Characteristics

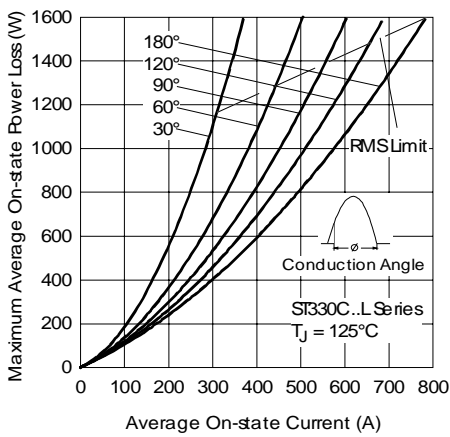


Fig. 5 - On-state Power Loss Characteristics

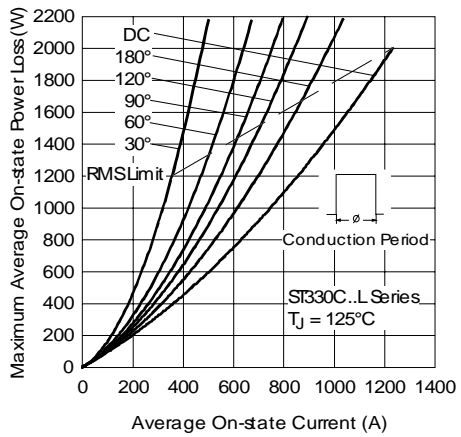


Fig. 6 - On-state Power Loss Characteristics

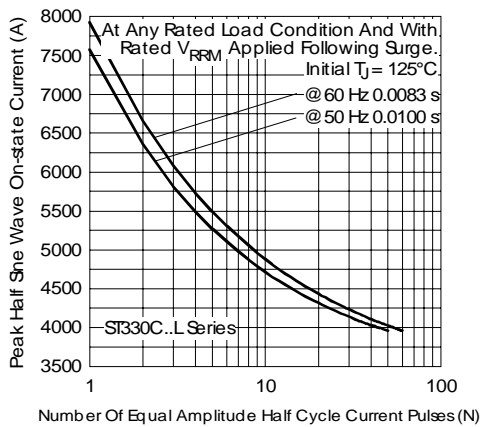


Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

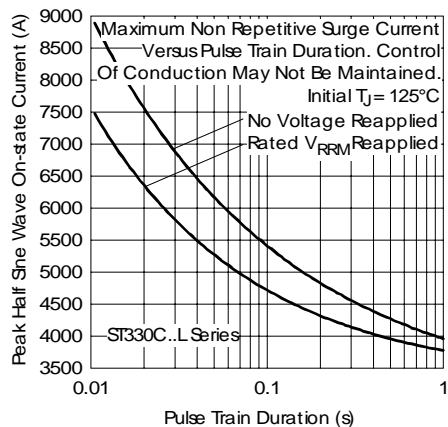


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

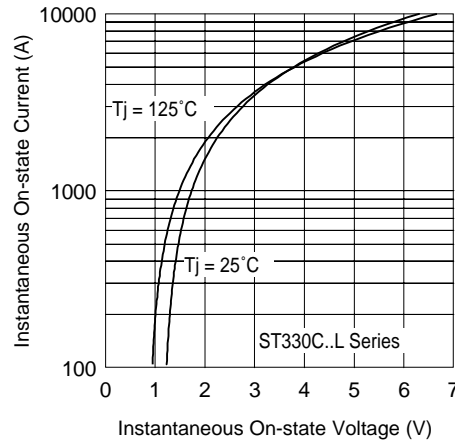


Fig. 9 - On-state Voltage Drop Characteristics

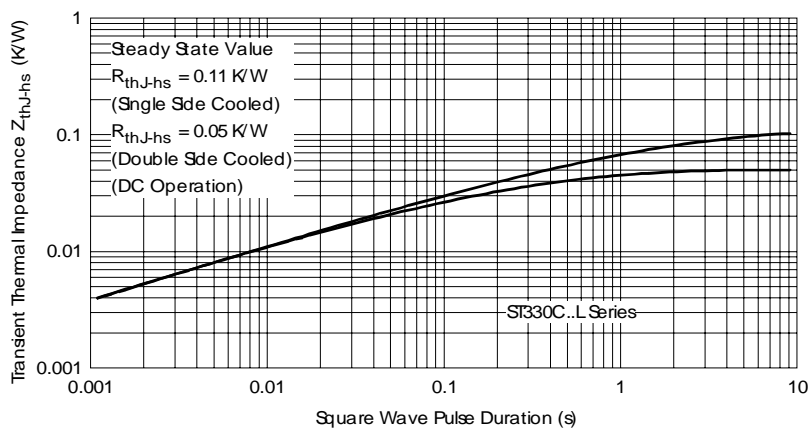


Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristics

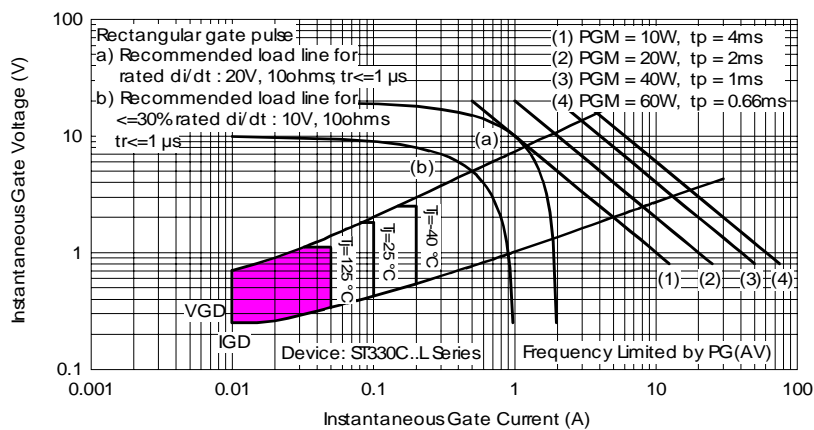


Fig. 11 - Gate Characteristics

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Data and specifications subject to change without notice.
This product has been designed and qualified for Industrial Level.
Qualification Standards can be found on IR's Web site.

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